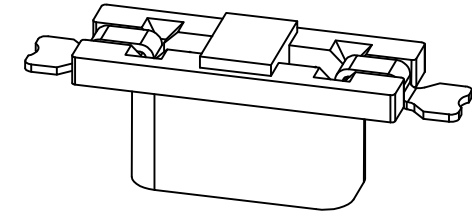
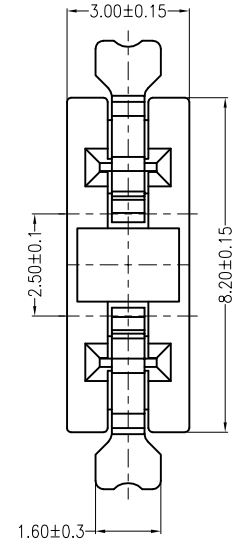
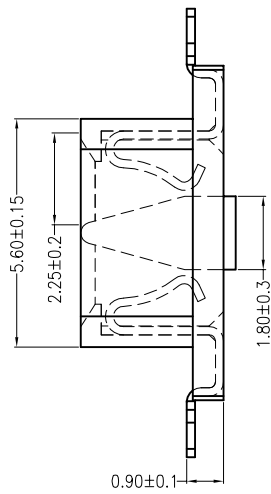
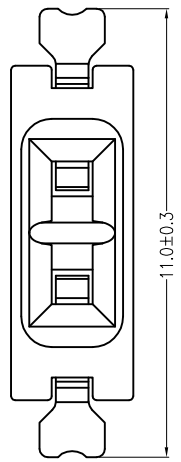


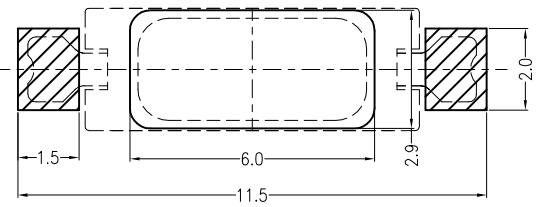
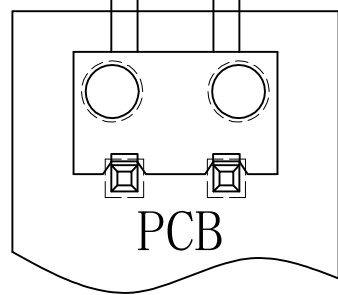
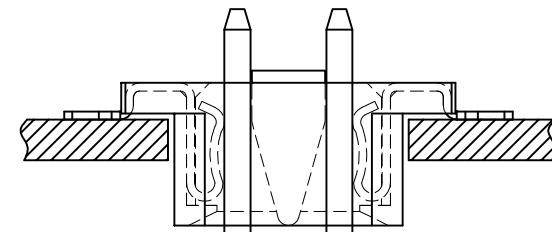
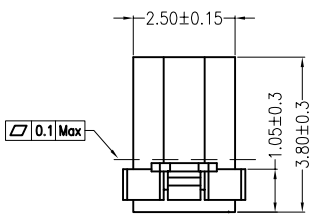
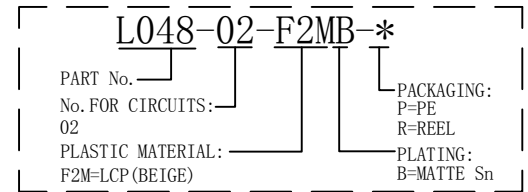
REV	DESCRIPTION	DESIGN	DATE
A0	Release	吴丹平	2016.04.30



主要技术参数 Main Specifications

- 线数 (Poles): 02
- 接触电阻 (Contact resistance): $\leq 20m\Omega$
- 绝缘电阻 (Insulation resistance): $\geq 1000M\Omega$
- 额定电压 (Rated voltage): 125V AC DC
- 额定电流 (Rated current): 1.0A AC DC
- 耐电压 (Withstand Voltage): 1500V AC/minute
- 温度范围 (Temperature Range): $-40^{\circ}C \sim +120^{\circ}C$


ORDER INFORMATION:



Board Layout

Assembly Layout

C				
B	CONTACT	2 PCS	PhosphorBronze	MATTE Sn-plated
A	PEDESTAL	1 PCS	LCP	UL 94V-0, COLOR:BEIGE
ITEM	COMPONENT	Q'TY	MATERIAL	FINISH


东莞市高迪电子有限公司
DONG GUAN GAO DI ELECTRONICS CO., LTD

TITLE: -
 2.5mmPITCH 180°WAFER SMT TYPE

PART NO.:
 L048-02-F2MB-*

DWG NO.:
 GCCP-0160

SCALE
 1 : 1

SHEET
 1 / 1

USE: CUSTOMER
APPD: 邵敬和
CHKD: 田峰
DR: 周秀龙

UNITS: mm